

In the Claims

1. (Previously Presented) An aqueous-based removal composition comprising a fluoride source, at least one organic amine, at least one organic solvent, water, optionally at least one chelating agent, and optionally at least one surfactant, wherein the at least one organic amine comprises a species selected from the group consisting of N-(2-cyanoethyl) ethylenediamine, hydroxypropylpiperazine, aminopropylpiperazine, hydroxypropylmorpholine, aminoethylmorpholine, ethylene urea, trimethylaminoethylethanolamine, trimethylaminopropylethanolamine, and N-(2-cyanopropyl) ethylenediamine, and wherein said composition is useful for removing photoresist, bottom anti-reflective coating (BARC) materials, and/or gap fill materials from a substrate having such material(s) thereon.
2. (Previously Presented) The composition of claim 1, wherein the at least one organic amine comprises N-(2-cyanoethyl)ethylenediamine.
3. (Previously Presented) The composition of claim 1, wherein the fluoride source comprises a fluoride-containing compound selected from the group consisting of ammonium fluoride, hydrogen fluoride, ammonium bifluoride, tetraalkylammonium difluoride, alkyl phosphonium difluoride, and triethylamine trihydrofluoride.
4. (Previously Presented) The composition of claim 1, wherein the fluoride source comprises ammonium fluoride.
5. (Previously Presented) The composition of claim 1, further comprising at least one additional organic amine.
6. (Previously Presented) The composition of claim 5, wherein the at least one additional organic amine comprises an amine-containing compound selected from the group consisting of hydroxyethylpiperazine, hydroxypropylpiperazine, aminoethylpiperazine, aminopropylpiperazine,

hydroxyethylmorpholine, hydroxypropylmorpholine, aminoethylmorpholine, aminopropylmorpholine, triethanolamine, pentamethyldiethylenetriamine, dimethylaminoethoxyethanol, aminoethoxyethanol, ethylene urea, trimethylaminoethylethanolamine, trimethylaminopropylethanolamine, and N-(2-cyanopropyl) ethylenediamine.

7. (Previously Presented) The composition of claim 1, wherein the at least one organic solvent comprises a compound selected from the group consisting of 1,4-butanediol, 1,3-butanediol, ethylene glycol, propylene glycol, N-methyl-2-pyrrolidone, DMSO, r-butyrolactone, propylene glycol monomethyl ether, propylene glycol monomethyl ether acetate, diethyleneglycol monobenzylether, ethyl lactate, ammonium lactate, and dimethyl acetamide.

8. (Previously Presented) The composition of claim 1, wherein the at least one organic solvent comprises propylene glycol monomethyl ether.

9. (Previously Presented) The composition of claim 1, comprising chelating agent.

10. (Original) The composition of claim 9, wherein the chelating agent comprises a compound selected from the group consisting of iminodiacetic acid, boric acid, ammonium borate, ammonium tetraborate, gluconic acid, mannitol, and sorbitol.

11. (Previously Presented) The composition of claim 1, comprising surfactant.

12. (Original) The composition of claim 11, wherein the surfactant comprises a compound selected from the group consisting of: (C₁-C₁₅) alkyl glucosides; (C₁-C₁₅) alkyl ethylene oxide/propylene oxide; (C₁-C₁₀) alkyl phenoxy ethylene oxide/propylene oxide; and oxirane, methyl-, polymer with oxirane, ether with 2, 2'-(oxidoimino)bis(ethanol) (2:1) and N(-3-(C(-11-isoalkyloxy)propyl) derivatives.

13. (Previously Presented) The composition of claim 11, wherein the surfactant comprises a compound selected from the group consisting of decyl glucoside, alkyl EOPO amine oxide, EO octylphenol, and EO nonylphenol.

14. (Canceled)

15. (Previously Presented) The composition of claim 1, selected from the group consisting of Formulations A- F, wherein all percentages are by weight, based on total weight of the formulation:

Formulation A

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.05 % decyl glucoside;

Formulation B

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 25 % propylene glycol monomethyl ether; and

about 30 % de-ionized water;

Formulation C

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 24 % propylene glycol monomethyl ether;

about 30 % de-ionized water; and

about 1 % ammonium tetraborate;

Formulation D

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.10 % alkyl EOPO amine oxide surfactant;

Formulation E

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.10 % EO octylphenol surfactant; and

Formulation F

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.10 % EO nonylphenol surfactant;

wherein the total of the weight percentages of such components of the composition does not exceed 100 % by weight.

16. (Previously Presented) The composition of claim 1, comprising the following components, based on total weight of the composition:

0.1 % wt. – 15.0 % wt. fluoride source;

20.0 % wt. - 60.0 % wt. total organic amine;

1.0 % wt. – 60.0 % wt. total organic solvent;

20.0 % wt. – 70.0 % wt. water;

0.000 % wt. – 20.0 % wt. chelating agent; and

0.000 % wt. – 5.0 % wt. surfactant,

wherein the total of the weight percentages of such components of the composition does not exceed 100 % by weight.

17. (Previously Presented) The composition of claim 1, wherein the pH of the composition is in a range from about 5 to about 9.

18. (Withdrawn) A method of removing photoresist, BARC material, and/or gap fill material from a substrate having said material(s) thereon, said method comprising contacting the substrate with an aqueous-based removal composition for sufficient time to at least partially remove said material from the substrate, wherein the aqueous-based removal composition includes a fluoride source, at least one organic amine, at least one organic solvent, water, optionally at least one chelating agent, and optionally at least one surfactant, wherein the at least one organic amine comprises a species selected from the group consisting of N-(2-cyanoethyl) ethylenediamine, hydroxypropylpiperazine, aminopropylpiperazine, hydroxypropylmorpholine, aminoethylmorpholine, ethylene urea, trimethylaminoethylethanolamine, trimethylaminopropylethanolamine, and N-(2-cyanopropyl) ethylenediamine.

19. (Canceled)

20. (Withdrawn) The method of claim 18, wherein the substrate comprises a semiconductor device structure.

21.-24. (Canceled)

25. (Withdrawn) The method of claim 18, wherein said contacting is carried out for a time of from about 1 minute to about 5 minutes.

26. (Withdrawn) The method of claim 18, wherein said contacting is carried out at temperature in a range of from about 20°C to about 40°C.

27. (Withdrawn) The method of claim 18, wherein the fluoride source comprises a fluoride-containing compound selected from the group consisting of ammonium fluoride, hydrogen fluoride, ammonium bifluoride, tetraalkylammonium difluoride, alkyl phosphonium difluoride, and triethylamine trihydrofluoride.
28. (Withdrawn) The method of claim 18, wherein the at least one organic amine comprises N-(2-cyanoethyl)ethylenediamine.
29. (Withdrawn) The method of claim 18, wherein the aqueous-based removal composition further comprises at least one additional organic amine.
30. (Withdrawn) The method of claim 29, wherein the at least one additional organic amine comprises an amine-containing compound selected from the group consisting of hydroxyethylpiperazine, hydroxypropylpiperazine, aminoethylpiperazine, aminopropylpiperazine, hydroxyethylmorpholine, hydroxypropylmorpholine, aminoethylmorpholine, aminopropylmorpholine, triethanolamine, pentamethyldiethylenetriamine, dimethylaminoethoxyethanol, aminoethoxyethanol, ethylene urea, trimethylaminoethylethanolamine, trimethylaminopropylethanolamine, and N-(2-cyanopropyl) ethylenediamine.
31. (Withdrawn) The method of claim 18, wherein the at least one organic solvent comprises a compound selected from the group consisting of 1,4-butanediol, 1,3-butanediol, ethylene glycol, propylene glycol, N-methyl-2-pyrrolidone, DMSO, r-butyrolactone, propylene glycol monomethyl ether, propylene glycol monomethyl ether acetate, diethyleneglycol monobenzylether, ethyl lactate, ammonium lactate, and dimethyl acetamide.
32. (Canceled)

33. (Withdrawn) The method of claim 18, comprising at least one chelating agent selected from the group consisting of iminodiacetic acid, boric acid, ammonium borate, ammonium tetraborate, gluconic acid, mannitol, and sorbitol.

34. (Canceled)

35. (Withdrawn) The method of claim 18, comprising at least one surfactant selected from the group consisting of: (C₁-C₁₅) alkyl glucosides; (C₁-C₁₅) alkyl ethylene oxide/propylene oxide; (C₁-C₁₀) alkyl phenoxy ethylene oxide/propylene oxide; and oxirane, methyl-, polymer with oxirane, ether with 2, 2'-(oxidoimino)bis(ethanol) (2:1) and N(-3-(C(-11-isoalkyloxy)propyl) derivatives.

36.-38. (Canceled)

39. (Withdrawn) The method of claim 18, selected from the group consisting of Formulations A-F, wherein all percentages are by weight, based on total weight of the formulation:

Formulation A

about 8 % NH₄F/HF;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.05 % decyl glucoside;

Formulation B

about 8 % NH₄F/HF;

about 30 % hydroxyethylmorpholine;
about 7 % N-(2-cyanoethyl) ethylenediamine;
about 25 % propylene glycol monomethyl ether; and
about 30 % de-ionized water;

Formulation C

about 8 % $\text{NH}_4\text{F}/\text{HF}$;
about 30 % hydroxyethylmorpholine;
about 7 % N-(2-cyanoethyl) ethylenediamine;
about 24 % propylene glycol monomethyl ether;
about 30 % de-ionized water; and
about 1 % ammonium tetraborate;

Formulation D

about 8 % $\text{NH}_4\text{F}/\text{HF}$;
about 30 % hydroxyethylmorpholine;
about 7 % N-(2-cyanoethyl) ethylenediamine;
about 15 % propylene glycol monomethyl ether;
about 40 % de-ionized water; and
about 0.10 % alkyl EOPO amine oxide surfactant;

Formulation E

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.10 % EO octylphenol surfactant; and

Formulation F

about 8 % $\text{NH}_4\text{F}/\text{HF}$;

about 30 % hydroxyethylmorpholine;

about 7 % N-(2-cyanoethyl) ethylenediamine;

about 15 % propylene glycol monomethyl ether;

about 40 % de-ionized water; and

about 0.10 % EO nonylphenol surfactant;

wherein the total of the weight percentages of such components of the composition does not exceed 100 % by weight.

40. (Withdrawn) The method of claim 18, wherein the composition comprises the following components, based on total weight of the composition:

0.1 % wt. – 15.0 % wt. fluoride source;

20.0 % wt. - 60.0 % wt. total organic amine;

1.0 % wt. – 60.0 % wt. total organic solvent;

20.0 % wt. – 70.0 % wt. water;

0.000 % wt. – 20.0 % wt. chelating agent; and

0.000 % wt. – 5.0 % wt. surfactant,

wherein the total of the weight percentages of such components of the composition does not exceed 100 % by weight.

41. (Withdrawn) The method of claim 18, wherein the pH of the composition is in a range from about 5 to about 9.

42. (Withdrawn) The method of claim 18, further comprising contacting the substrate with deionized water following contact with the aqueous-based removal composition.

43. (Withdrawn) The method of claim 18, further comprising residue material selected from the group consisting of photoresist, BARC materials, gap fill materials, and combinations thereof.

44. (Cancelled)

45. (Cancelled)

46.-47. (Cancelled)